

ABSTRACT

A laminate 1 includes a substrate 2, an inorganic vapor deposition layer 3, an adhesive layer 5, and a resin film layer 6 in sequence. A barrier coat layer 4 is interposed between the substrate 2 and the inorganic vapor deposition layer 3 and/or between the inorganic vapor deposition layer 3 and the adhesive layer 5. The adhesive layer 5 has a thermal expansion coefficient of $100.0 \times 10^{-5} \text{K}^{-1}$ or less.